

1 | 2

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PRODUCT NO.
SEE CHART

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SECTION A-A

mat'l. code		tolerances unless otherwise specified		CUSTOMER COPY		www.fciconnect.com		
l	tr	ec	no	dr	date	linear	.0 ± 0.25	
N		N08-0170	SH	10/09/08				
H	ECR	V61355	BC LDH	02DCT96	angles			.00 ± 0.13
J	ECR	V61824	LW GREEN	09JAN97	dr	M CHENG	7/13/01	
K		S00022	LDV	01/25/00	en	M CHENG	7/13/01	
L		N04-0102	YS	11/23/04	chr	M CHENG	7/18/01	
M		N08-0097	SH	09/25/08	app	J HSIA	7/20/01	
sheet index		revision	M	M				title 4 POS VERT. SNAP PEG PCB III MOD JACK ASSY
sheet		1	2	product family MODJACK size dwg no A4 90511		code	NAN	
index		sheet	1	2	scale A4		sheet 1 of	

path no.

1 | 2

PDM: Rev:N

3

STATUS: Released

Printed: Nov 06, 2008

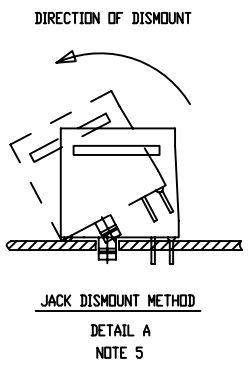
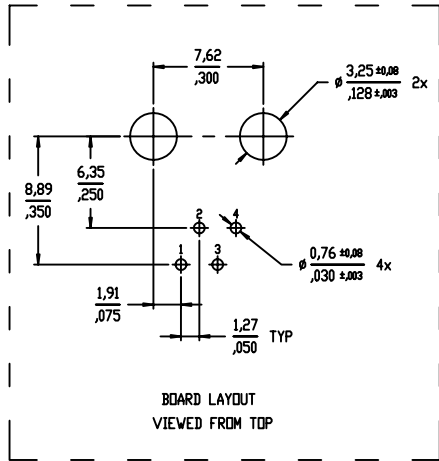
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PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	NOTES	PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	REMARKS
90511-001 -001LF -001HLF	ALL	GXT	BLACK	90511-101 -101LF -101HLF	ALL	GXT	NOT TOOLED
-002 -002LF -002HLF	ALL	30u" / ,76u Au	BLACK	-102 -102LF -102HLF	ALL	30u" / ,76u Au	NOT TOOLED
-003 -003LF	ALL	GXT	GREY				
-004 -004LF	ALL	30u" / ,76u Au	GREY				
-005 -005LF -005HLF	ALL	50u" / 1,27u Au	BLACK				

LEAD FREE PRODUCT NO.
MEETS PIP PROCESS PRODUCT NO.



NOTES :

- P/NO WITH DASH 0XX -NORMAL WAVE SOLDERING APPLICATION. P/NO WITH DASH 1XX -IR REFLOW APPLICATION (NOT TOOLED).
- PACKAGING SPEC. BUS-14-164.
- SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- JACK IS FOR 1,57/.062 THICK PCB.
- SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB, PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- THESE DIMENSIONS ARE TAKEN FROM THE TOP OF THE PEG.
- GXT IS 0,76um / 30u" MIN GXT WITH Au FLASH OVER 1,27 um / 50u" MIN NI.
- THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.
- EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTDEMR .

mat'l. code		tolerances unless otherwise specified		CUSTOMER COPY		FCI www.fciconnect.com	
ltr	ecrn no	dr	date	linear	projection	title	
				.0 ± 0.25		4 POS VERT. SNAP PEG PCB III MOD JACK ASSY	
				.00 ± 0.13		product family MODJACK	
				.000 ± 0.05		code	
				± 2°		size	
				dr	scale	A4	
				engr		90511	
				chr		sheet	
				appd		2of	
sheet	revision	M	M				
index	sheet	1	2				